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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Active
Number of LABs/CLBs	3411
Number of Logic Elements/Cells	43661
Total RAM Bits	2138112
Number of I/O	296
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-FBGA, CSPBGA
Supplier Device Package	484-CSPBGA (19x19)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc6slx45t-3csg484i">https://www.e-xfl.com/product-detail/xilinx/xc6slx45t-3csg484i</a>

Table 1: Absolute Maximum Ratings<sup>(1)</sup> (Cont'd)

Symbol	Description			Units		
$V_{IN}$ and $V_{TS}^{(3)}$	I/O input voltage or voltage applied to 3-state output, relative to GND <sup>(4)</sup>	All user and dedicated I/Os	Commercial	DC	-0.60 to 4.10	V
				20% overshoot duration	-0.75 to 4.25	V
				8% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
		Industrial	DC	DC	-0.60 to 3.95	V
				20% overshoot duration	-0.75 to 4.15	V
				4% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
		Expanded (Q)	DC	DC	-0.60 to 3.95	V
				20% overshoot duration	-0.75 to 4.15	V
				4% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
		Restricted to maximum of 100 user I/Os	Commercial	20% overshoot duration	-0.75 to 4.35	V
				15% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
				10% overshoot duration	-0.75 to 4.45	V
		Industrial	20% overshoot duration	20% overshoot duration	-0.75 to 4.25	V
				10% overshoot duration	-0.75 to 4.35	V
				8% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
		Expanded (Q)	20% overshoot duration	20% overshoot duration	-0.75 to 4.25	V
				10% overshoot duration	-0.75 to 4.35	V
				8% overshoot duration <sup>(5)</sup>	-0.75 to 4.40	V
$T_{STG}$	Storage temperature (ambient)			-65 to 150	°C	
$T_{SOL}$	Maximum soldering temperature <sup>(6)</sup> (TQG144, CPG196, CSG225, CSG324, CSG484, and FTG256)			+260	°C	
	Maximum soldering temperature <sup>(6)</sup> (Pb-free packages: FGG484, FGG676, and FGG900)			+250	°C	
	Maximum soldering temperature <sup>(6)</sup> (Pb packages: CS484, FT256, FG484, FG676, and FG900)			+220	°C	
$T_j$	Maximum junction temperature <sup>(6)</sup>			+125	°C	

**Notes:**

- Stresses beyond those listed under Absolute Maximum Ratings might cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time might affect device reliability.
- When programming eFUSE,  $V_{FS} \leq V_{CCAUX}$ . Requires up to 40 mA current. For read mode,  $V_{FS}$  can be between GND and 3.45 V.
- I/O absolute maximum limit applied to DC and AC signals. Overshoot duration is the percentage of a data period that the I/O is stressed beyond 3.45V.
- For I/O operation, refer to [UG381: Spartan-6 FPGA SelectIO Resources User Guide](#).
- Maximum percent overshoot duration to meet 4.40V maximum.
- For soldering guidelines and thermal considerations, see [UG385: Spartan-6 FPGA Packaging and Pinout Specification](#).

## Quiescent Current

Typical values for quiescent supply current are specified at nominal voltage, 25°C junction temperatures ( $T_j$ ). Quiescent supply current is specified by speed grade for Spartan-6 devices. Xilinx recommends analyzing static power consumption using the XPOWER™ Estimator (XPE) tool (download at <http://www.xilinx.com/power>) for conditions other than those specified in Table 5.

Table 5: Typical Quiescent Supply Current

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
$I_{CCINTQ}$	Quiescent $V_{CCINT}$ supply current	LX4	4.0	4.0	4.0	2.4	mA
		LX9	4.0	4.0	4.0	2.4	mA
		LX16	6.0	6.0	6.0	4.0	mA
		LX25	11.0	11.0	11.0	6.6	mA
		LX25T	11.0	11.0	11.0	N/A	mA
		LX45	15.0	15.0	15.0	9.0	mA
		LX45T	15.0	15.0	15.0	N/A	mA
		LX75	29.0	29.0	29.0	17.4	mA
		LX75T	29.0	29.0	29.0	N/A	mA
		LX100	36.0	36.0	36.0	21.6	mA
		LX100T	36.0	36.0	36.0	N/A	mA
		LX150	51.0	51.0	51.0	31.0	mA
		LX150T	51.0	51.0	51.0	N/A	mA
$I_{CCOQ}$	Quiescent $V_{CCO}$ supply current	LX4	1.0	1.0	1.0	1.0	mA
		LX9	1.0	1.0	1.0	1.0	mA
		LX16	2.0	2.0	2.0	2.0	mA
		LX25	2.0	2.0	2.0	2.0	mA
		LX25T	2.0	2.0	2.0	N/A	mA
		LX45	3.0	3.0	3.0	3.0	mA
		LX45T	3.0	3.0	3.0	N/A	mA
		LX75	4.0	4.0	4.0	4.0	mA
		LX75T	4.0	4.0	4.0	N/A	mA
		LX100	5.0	5.0	5.0	5.0	mA
		LX100T	5.0	5.0	5.0	N/A	mA
		LX150	7.0	7.0	7.0	7.0	mA
		LX150T	7.0	7.0	7.0	N/A	mA

Table 21: GTP Transceiver User Clock Switching Characteristics<sup>(1)</sup>

Symbol	Description	Conditions	Speed Grade				Units
			-3	-3N	-2	-1L	
$F_{TXOUT}$	TXOUTCLK maximum frequency		320	320	270	N/A	MHz
$F_{RXREC}$	RXRECCCLK maximum frequency		320	320	270	N/A	MHz
$T_{RX}$	RXUSRCLK maximum frequency		320	320	270	N/A	MHz
$T_{RX2}$	RXUSRCLK2 maximum frequency	1 byte interface	156.25	156.25	125	N/A	MHz
		2 byte interface	160	160	125	N/A	MHz
		4 byte interface	80	80	67.5	N/A	MHz
$T_{TX}$	TXUSRCLK maximum frequency		320	320	270	N/A	MHz
$T_{TX2}$	TXUSRCLK2 maximum frequency	1 byte interface	156.25	156.25	125	N/A	MHz
		2 byte interface	160	160	125	N/A	MHz
		4 byte interface	80	80	67.5	N/A	MHz

## Notes:

1. Clocking must be implemented as described in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#).

Table 22: GTP Transceiver Transmitter Switching Characteristics

Symbol	Description	Condition	Min	Typ	Max	Units
$T_{RTX}$	TX Rise time	20%–80%	—	140	—	ps
$T_{FTX}$	TX Fall time	80%–20%	—	120	—	ps
$T_{LLSKEW}$	TX lane-to-lane skew <sup>(1)</sup>		—	—	400	ps
$V_{TXOOBVDP}$	Electrical idle amplitude		—	—	20	mV
$T_{TXOOBTTRANSITION}$	Electrical idle transition time		—	—	50	ns
$T_{J3.125}$	Total Jitter <sup>(2)</sup>	3.125 Gb/s	—	—	0.35	UI
$D_{J3.125}$	Deterministic Jitter <sup>(2)</sup>		—	—	0.15	UI
$T_{J2.5}$	Total Jitter <sup>(2)</sup>	2.5 Gb/s	—	—	0.33	UI
$D_{J2.5}$	Deterministic Jitter <sup>(2)</sup>		—	—	0.15	UI
$T_{J1.62}$	Total Jitter <sup>(2)</sup>	1.62 Gb/s	—	—	0.20	UI
$D_{J1.62}$	Deterministic Jitter <sup>(2)</sup>		—	—	0.10	UI
$T_{J1.25}$	Total Jitter <sup>(2)</sup>	1.25 Gb/s	—	—	0.20	UI
$D_{J1.25}$	Deterministic Jitter <sup>(2)</sup>		—	—	0.10	UI
$T_{J614}$	Total Jitter <sup>(2)</sup>	614 Mb/s	—	—	0.10	UI
$D_{J614}$	Deterministic Jitter <sup>(2)</sup>		—	—	0.05	UI

## Notes:

1. Using same REFCLK input with TXENPMAPHASEALIGN enabled for up to four consecutive GTP transceiver sites.  
 2. Using PLL\_DIVSEL\_FB = 2, INTDATAWIDTH = 1. These values are NOT intended for protocol specific compliance determinations.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

I/O Standard	T <sub>IOPI</sub>				T <sub>IOOP</sub>				T <sub>IOTP</sub>				Units	
	Speed Grade				Speed Grade				Speed Grade					
	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>	-3	-3N	-2	-1L <sup>(1)</sup>		
LVTTL, QUIETIO, 2 mA	1.35	1.47	1.60	1.82	5.39	5.53	5.73	6.37	5.39	5.53	5.73	6.37	ns	
LVTTL, QUIETIO, 4 mA	1.35	1.47	1.60	1.82	4.29	4.43	4.63	5.22	4.29	4.43	4.63	5.22	ns	
LVTTL, QUIETIO, 6 mA	1.35	1.47	1.60	1.82	3.75	3.89	4.09	4.69	3.75	3.89	4.09	4.69	ns	
LVTTL, QUIETIO, 8 mA	1.35	1.47	1.60	1.82	3.23	3.37	3.57	4.20	3.23	3.37	3.57	4.20	ns	
LVTTL, QUIETIO, 12 mA	1.35	1.47	1.60	1.82	3.28	3.42	3.62	4.22	3.28	3.42	3.62	4.22	ns	
LVTTL, QUIETIO, 16 mA	1.35	1.47	1.60	1.82	2.94	3.08	3.28	3.92	2.94	3.08	3.28	3.92	ns	
LVTTL, QUIETIO, 24 mA	1.35	1.47	1.60	1.82	2.69	2.83	3.03	3.67	2.69	2.83	3.03	3.67	ns	
LVTTL, Slow, 2 mA	1.35	1.47	1.60	1.82	4.36	4.50	4.70	5.30	4.36	4.50	4.70	5.30	ns	
LVTTL, Slow, 4 mA	1.35	1.47	1.60	1.82	3.17	3.31	3.51	4.16	3.17	3.31	3.51	4.16	ns	
LVTTL, Slow, 6 mA	1.35	1.47	1.60	1.82	2.76	2.90	3.10	3.75	2.76	2.90	3.10	3.75	ns	
LVTTL, Slow, 8 mA	1.35	1.47	1.60	1.82	2.59	2.73	2.93	3.55	2.59	2.73	2.93	3.55	ns	
LVTTL, Slow, 12 mA	1.35	1.47	1.60	1.82	2.58	2.72	2.92	3.54	2.58	2.72	2.92	3.54	ns	
LVTTL, Slow, 16 mA	1.35	1.47	1.60	1.82	2.39	2.53	2.73	3.40	2.39	2.53	2.73	3.40	ns	
LVTTL, Slow, 24 mA	1.35	1.47	1.60	1.82	2.28	2.42	2.62	3.24	2.28	2.42	2.62	3.24	ns	
LVTTL, Fast, 2 mA	1.35	1.47	1.60	1.82	3.78	3.92	4.12	4.74	3.78	3.92	4.12	4.74	ns	
LVTTL, Fast, 4 mA	1.35	1.47	1.60	1.82	2.49	2.63	2.83	3.45	2.49	2.63	2.83	3.45	ns	
LVTTL, Fast, 6 mA	1.35	1.47	1.60	1.82	2.44	2.58	2.78	3.40	2.44	2.58	2.78	3.40	ns	
LVTTL, Fast, 8 mA	1.35	1.47	1.60	1.82	2.32	2.46	2.66	3.28	2.32	2.46	2.66	3.28	ns	
LVTTL, Fast, 12 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns	
LVTTL, Fast, 16 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns	
LVTTL, Fast, 24 mA	1.35	1.47	1.60	1.82	1.83	1.97	2.17	2.79	1.83	1.97	2.17	2.79	ns	
LVCMOS33, QUIETIO, 2 mA	1.34	1.46	1.59	1.82	5.40	5.54	5.74	6.37	5.40	5.54	5.74	6.37	ns	
LVCMOS33, QUIETIO, 4 mA	1.34	1.46	1.59	1.82	4.03	4.17	4.37	5.01	4.03	4.17	4.37	5.01	ns	
LVCMOS33, QUIETIO, 6 mA	1.34	1.46	1.59	1.82	3.51	3.65	3.85	4.47	3.51	3.65	3.85	4.47	ns	
LVCMOS33, QUIETIO, 8 mA	1.34	1.46	1.59	1.82	3.37	3.51	3.71	4.33	3.37	3.51	3.71	4.33	ns	
LVCMOS33, QUIETIO, 12 mA	1.34	1.46	1.59	1.82	2.94	3.08	3.28	3.93	2.94	3.08	3.28	3.93	ns	
LVCMOS33, QUIETIO, 16 mA	1.34	1.46	1.59	1.82	2.77	2.91	3.11	3.78	2.77	2.91	3.11	3.78	ns	
LVCMOS33, QUIETIO, 24 mA	1.34	1.46	1.59	1.82	2.59	2.73	2.93	3.58	2.59	2.73	2.93	3.58	ns	
LVCMOS33, Slow, 2 mA	1.34	1.46	1.59	1.82	4.37	4.51	4.71	5.28	4.37	4.51	4.71	5.28	ns	
LVCMOS33, Slow, 4 mA	1.34	1.46	1.59	1.82	2.98	3.12	3.32	3.94	2.98	3.12	3.32	3.94	ns	
LVCMOS33, Slow, 6 mA	1.34	1.46	1.59	1.82	2.58	2.72	2.92	3.61	2.58	2.72	2.92	3.61	ns	
LVCMOS33, Slow, 8 mA	1.34	1.46	1.59	1.82	2.65	2.79	2.99	3.61	2.65	2.79	2.99	3.61	ns	
LVCMOS33, Slow, 12 mA	1.34	1.46	1.59	1.82	2.39	2.53	2.73	3.31	2.39	2.53	2.73	3.31	ns	
LVCMOS33, Slow, 16 mA	1.34	1.46	1.59	1.82	2.31	2.45	2.65	3.27	2.31	2.45	2.65	3.27	ns	
LVCMOS33, Slow, 24 mA	1.34	1.46	1.59	1.82	2.28	2.42	2.62	3.24	2.28	2.42	2.62	3.24	ns	
LVCMOS33, Fast, 2 mA	1.34	1.46	1.59	1.82	3.76	3.90	4.10	4.70	3.76	3.90	4.10	4.70	ns	
LVCMOS33, Fast, 4 mA	1.34	1.46	1.59	1.82	2.48	2.62	2.82	3.44	2.48	2.62	2.82	3.44	ns	
LVCMOS33, Fast, 6 mA	1.34	1.46	1.59	1.82	2.32	2.46	2.66	3.28	2.32	2.46	2.66	3.28	ns	

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOP1</sub>		T <sub>IOOP</sub>		T <sub>IOTP</sub>		Units	
	Speed Grade		Speed Grade		Speed Grade			
	-3	-2	-3	-2	-3	-2		
DIFF_SSTL3_I	1.26	1.44	1.95	2.15	1.95	2.15	ns	
DIFF_SSTL3_II	1.26	1.44	1.94	2.14	1.94	2.14	ns	
DIFF_SSTL2_I	1.09	1.27	1.94	2.14	1.94	2.14	ns	
DIFF_SSTL2_II	1.09	1.27	1.90	2.10	1.90	2.10	ns	
DIFF_SSTL18_I	1.04	1.22	1.86	2.06	1.86	2.06	ns	
DIFF_SSTL18_II	1.05	1.23	1.82	2.02	1.82	2.02	ns	
DIFF_SSTL15_II	1.01	1.19	1.81	2.01	1.81	2.01	ns	
DIFF_MOBILE_DDR	1.04	1.22	1.89	2.09	1.89	2.09	ns	
LVTTL, QUIETIO, 2 mA	1.42	1.60	5.64	5.84	5.64	5.84	ns	
LVTTL, QUIETIO, 4 mA	1.42	1.60	4.46	4.66	4.46	4.66	ns	
LVTTL, QUIETIO, 6 mA	1.42	1.60	3.92	4.12	3.92	4.12	ns	
LVTTL, QUIETIO, 8 mA	1.42	1.60	3.37	3.57	3.37	3.57	ns	
LVTTL, QUIETIO, 12 mA	1.42	1.60	3.42	3.62	3.42	3.62	ns	
LVTTL, QUIETIO, 16 mA	1.42	1.60	3.09	3.29	3.09	3.29	ns	
LVTTL, QUIETIO, 24 mA	1.42	1.60	2.83	3.03	2.83	3.03	ns	
LVTTL, Slow, 2 mA	1.42	1.60	4.58	4.78	4.58	4.78	ns	
LVTTL, Slow, 4 mA	1.42	1.60	3.38	3.58	3.38	3.58	ns	
LVTTL, Slow, 6 mA	1.42	1.60	2.95	3.15	2.95	3.15	ns	
LVTTL, Slow, 8 mA	1.42	1.60	2.73	2.93	2.73	2.93	ns	
LVTTL, Slow, 12 mA	1.42	1.60	2.72	2.92	2.72	2.92	ns	
LVTTL, Slow, 16 mA	1.42	1.60	2.53	2.73	2.53	2.73	ns	
LVTTL, Slow, 24 mA	1.42	1.60	2.42	2.62	2.42	2.62	ns	
LVTTL, Fast, 2 mA	1.42	1.60	4.04	4.24	4.04	4.24	ns	
LVTTL, Fast, 4 mA	1.42	1.60	2.66	2.86	2.66	2.86	ns	
LVTTL, Fast, 6 mA	1.42	1.60	2.58	2.78	2.58	2.78	ns	
LVTTL, Fast, 8 mA	1.42	1.60	2.46	2.66	2.46	2.66	ns	
LVTTL, Fast, 12 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns	
LVTTL, Fast, 16 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns	
LVTTL, Fast, 24 mA	1.42	1.60	1.97	2.17	1.97	2.17	ns	
LVCMOS33, QUIETIO, 2 mA	1.41	1.59	5.65	5.85	5.65	5.85	ns	
LVCMOS33, QUIETIO, 4 mA	1.41	1.59	4.20	4.40	4.20	4.40	ns	
LVCMOS33, QUIETIO, 6 mA	1.41	1.59	3.65	3.85	3.65	3.85	ns	
LVCMOS33, QUIETIO, 8 mA	1.41	1.59	3.51	3.71	3.51	3.71	ns	
LVCMOS33, QUIETIO, 12 mA	1.41	1.59	3.09	3.29	3.09	3.29	ns	
LVCMOS33, QUIETIO, 16 mA	1.41	1.59	2.91	3.11	2.91	3.11	ns	
LVCMOS33, QUIETIO, 24 mA	1.41	1.59	2.73	2.93	2.73	2.93	ns	
LVCMOS33, Slow, 2 mA	1.41	1.59	4.59	4.79	4.59	4.79	ns	
LVCMOS33, Slow, 4 mA	1.41	1.59	3.14	3.34	3.14	3.34	ns	

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices<sup>(1)</sup> (Cont'd)

I/O Standard	T <sub>IOP1</sub>		T <sub>IOP0</sub>		T <sub>IOTP</sub>		Units	
	Speed Grade		Speed Grade		Speed Grade			
	-3	-2	-3	-2	-3	-2		
LVCMOS15, QUIETIO, 2 mA	1.05	1.23	5.63	5.83	5.63	5.83	ns	
LVCMOS15, QUIETIO, 4 mA	1.05	1.23	4.75	4.95	4.75	4.95	ns	
LVCMOS15, QUIETIO, 6 mA	1.05	1.23	4.21	4.41	4.21	4.41	ns	
LVCMOS15, QUIETIO, 8 mA	1.05	1.23	4.05	4.25	4.05	4.25	ns	
LVCMOS15, QUIETIO, 12 mA	1.05	1.23	3.74	3.94	3.74	3.94	ns	
LVCMOS15, QUIETIO, 16 mA	1.05	1.23	3.52	3.72	3.52	3.72	ns	
LVCMOS15, Slow, 2 mA	1.05	1.23	4.32	4.52	4.32	4.52	ns	
LVCMOS15, Slow, 4 mA	1.05	1.23	3.58	3.78	3.58	3.78	ns	
LVCMOS15, Slow, 6 mA	1.05	1.23	2.45	2.65	2.45	2.65	ns	
LVCMOS15, Slow, 8 mA	1.05	1.23	2.46	2.66	2.46	2.66	ns	
LVCMOS15, Slow, 12 mA	1.05	1.23	2.17	2.37	2.17	2.37	ns	
LVCMOS15, Slow, 16 mA	1.05	1.23	2.15	2.35	2.15	2.35	ns	
LVCMOS15, Fast, 2 mA	1.05	1.23	3.43	3.63	3.43	3.63	ns	
LVCMOS15, Fast, 4 mA	1.05	1.23	2.42	2.62	2.42	2.62	ns	
LVCMOS15, Fast, 6 mA	1.05	1.23	1.92	2.12	1.92	2.12	ns	
LVCMOS15, Fast, 8 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15, Fast, 12 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15, Fast, 16 mA	1.05	1.23	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, QUIETIO, 2 mA	1.10	1.28	5.64	5.84	5.64	5.84	ns	
LVCMOS15_JEDEC, QUIETIO, 4 mA	1.10	1.28	4.75	4.95	4.75	4.95	ns	
LVCMOS15_JEDEC, QUIETIO, 6 mA	1.10	1.28	4.21	4.41	4.21	4.41	ns	
LVCMOS15_JEDEC, QUIETIO, 8 mA	1.10	1.28	4.06	4.26	4.06	4.26	ns	
LVCMOS15_JEDEC, QUIETIO, 12 mA	1.10	1.28	3.75	3.95	3.75	3.95	ns	
LVCMOS15_JEDEC, QUIETIO, 16 mA	1.10	1.28	3.53	3.73	3.53	3.73	ns	
LVCMOS15_JEDEC, Slow, 2 mA	1.10	1.28	4.32	4.52	4.32	4.52	ns	
LVCMOS15_JEDEC, Slow, 4 mA	1.10	1.28	3.56	3.76	3.56	3.76	ns	
LVCMOS15_JEDEC, Slow, 6 mA	1.10	1.28	2.44	2.64	2.44	2.64	ns	
LVCMOS15_JEDEC, Slow, 8 mA	1.10	1.28	2.47	2.67	2.47	2.67	ns	
LVCMOS15_JEDEC, Slow, 12 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns	
LVCMOS15_JEDEC, Slow, 16 mA	1.10	1.28	2.15	2.35	2.15	2.35	ns	
LVCMOS15_JEDEC, Fast, 2 mA	1.10	1.28	3.43	3.63	3.43	3.63	ns	
LVCMOS15_JEDEC, Fast, 4 mA	1.10	1.28	2.42	2.62	2.42	2.62	ns	
LVCMOS15_JEDEC, Fast, 6 mA	1.10	1.28	1.92	2.12	1.92	2.12	ns	
LVCMOS15_JEDEC, Fast, 8 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, Fast, 12 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS15_JEDEC, Fast, 16 mA	1.10	1.28	1.87	2.07	1.87	2.07	ns	
LVCMOS12, QUIETIO, 2 mA	0.98	1.16	6.54	6.74	6.54	6.74	ns	
LVCMOS12, QUIETIO, 4 mA	0.98	1.16	5.12	5.32	5.12	5.32	ns	

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
1.2V	LVCMOS12, LVCMOS12_JEDEC	2	Fast	30 <sup>(1)</sup>	35	30	35
			Slow	51	55	51	52
			QuietIO	71	58	71	70
		4	Fast	17	17	17	19
			Slow	23	25	23	22
			QuietIO	35	32	35	32
		6	Fast	13	15	13	14
			Slow	19	20	19	17
			QuietIO	26	24	26	24
		8	Fast	N/A	12	N/A	12
			Slow	N/A	15	N/A	13
			QuietIO	N/A	20	N/A	19
		12	Fast	N/A	5	N/A	4
			Slow	N/A	8	N/A	5
			QuietIO	N/A	11	N/A	10

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
2.5V	LVCMS25	2	Fast	38	43	38	43		
			Slow	46	52	46	48		
			QuietIO	57	64	57	59		
		4	Fast	21	24	21	23		
			Slow	26	31	26	27		
			QuietIO	33	32	33	30		
		6	Fast	15	17	15	16		
			Slow	19	22	19	19		
			QuietIO	25	23	25	19		
		8	Fast	12	15	12	14		
			Slow	15	18	15	16		
			QuietIO	21	19	21	16		
		12	Fast	1	3	1	1		
			Slow	2	7	2	4		
			QuietIO	3	8	3	8		
		16	Fast	1	3	1	1		
			Slow	3	7	3	3		
			QuietIO	4	9	4	8		
		24	Fast	N/A	3	N/A	1		
			Slow	N/A	5	N/A	2		
			QuietIO	N/A	8	N/A	6		
SSTL_2_I <sup>(3)</sup>				10	11	10	11		
SSTL_2_II <sup>(3)</sup>				N/A	7	N/A	7		
DIFF_SSTL_2_I <sup>(3)</sup>				30	33	30	33		
DIFF_SSTL_2_II <sup>(3)</sup>				N/A	21	N/A	24		

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair					
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324			
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5		
3.3V	LVTTL	2	Fast	53	65	53	62		
			Slow	70	80	70	73		
			QuietIO	79	89	79	91		
		4	Fast	23	30	23	27		
			Slow	34	41	34	37		
			QuietIO	44	49	44	46		
		6	Fast	16	21	16	20		
			Slow	21	28	21	25		
			QuietIO	34	39	34	34		
		8	Fast	12	16	12	15		
			Slow	16	22	16	19		
			QuietIO	27	28	27	24		
		12	Fast	1	3	1	1		
			Slow	2	5	2	4		
			QuietIO	2	10	2	8		
		16	Fast	1	3	1	1		
			Slow	1	7	1	2		
			QuietIO	3	11	3	8		
		24	Fast	1	2	1	1		
			Slow	2	5	2	2		
			QuietIO	8	9	8	8		
PCI33_3				18	19	18	19		
PCI66_3				18	19	18	19		
SSTL_3_I				5	8	5	8		
SSTL_3_II				3	5	3	3		
DIFF_SSTL_3_I				15	24	15	24		
DIFF_SSTL_3_II				9	15	9	9		
SDIO				17	18	17	15		

Table 34: SSO Limit per V<sub>CCO</sub>/GND Pair (Cont'd)

V <sub>CCO</sub>	I/O Standard	Drive	Slew	SSO Limit per V <sub>CCO</sub> /GND Pair			
				All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324		All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324	
				Bank 0/2	Bank 1/3	Bank 0/2	Bank 1/3/4/5
Various	LVDS_33			16	N/A	16	N/A
	LVDS_25			20	N/A	20	N/A
	BLVDS_25			20	48	20	20
	MINI_LVDS_33			13	N/A	13	N/A
	MINI_LVDS_25			18	N/A	18	N/A
	RSDS_33			12	N/A	12	N/A
	RSDS_25			15	N/A	15	N/A
	TMDS_33			83	N/A	83	N/A
	PPDS_33			12	N/A	12	N/A
	PPDS_25			16	N/A	16	N/A
	DISPLAY_PORT			42	40	42	30
	I2C			47	55	47	42
	SMBUS			44	52	44	40

**Notes:**

1. SSO limits greater than the number of I/O per V<sub>CCO</sub>/GND pair (Table 33) indicate No Limit for the given I/O standard. They are provided in this table to calculate limits when using multiple I/O standards in a bank.
2. Not available (N/A) indicates that the I/O standard is not available in the given bank.
3. When used with the MCB, these signals are exempt from SSO analysis due to the known activity of the MCB switching patterns. SSO performance is validated for all MCB instances. MCB outputs can, in some cases, exceed the SSO limits.

## Input Serializer/Deserializer Switching Characteristics

Table 37: ISERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold for Control Lines</b>						
T <sub>ISCKC_BITSLIP</sub> / T <sub>ISCKC_BITSLIP</sub>	BITSLIP pin Setup/Hold with respect to CLKDIV	0.16/ -0.09	0.20/ -0.09	0.31/ -0.09	0.34/ -0.14	ns
T <sub>ISCKC_CE</sub> / T <sub>ISCKC_CE</sub>	CE pin Setup/Hold with respect to CLK	0.71/ -0.47	0.71/ -0.42	0.97/ -0.42	1.39/ -0.71	ns
<b>Setup/Hold for Data Lines</b>						
T <sub>ISDCK_D</sub> / T <sub>ISCKD_D</sub>	D pin Setup/Hold with respect to CLK	0.24/ -0.15	0.25/ -0.05	0.29/ -0.05	0.09/ -0.05	ns
T <sub>ISDCK_DDLY</sub> / T <sub>ISCKD_DDLY</sub>	DDLY pin Setup/Hold with respect to CLK (using IODELAY2)	-0.25/ 0.30	-0.25/ 0.42	-0.25/ 0.56	-0.54/ 0.67	ns
T <sub>ISDCK_D_DDR</sub> / T <sub>ISCKD_D_DDR</sub>	D pin Setup/Hold with respect to CLK at DDR mode	-0.03/ 0.04	-0.03/ 0.16	-0.03/ 0.18	-0.05/ 0.12	ns
T <sub>ISDCK_DDLY_DDR</sub> / T <sub>ISCKD_DDLY_DDR</sub>	D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY2)	-0.40/ 0.48	-0.40/ 0.53	-0.40/ 0.71	-0.71/ 0.86	ns
<b>Sequential Delays</b>						
T <sub>ISCKO_Q</sub>	CLKDIV to out at Q pin	1.30	1.44	2.02	2.22	ns
F <sub>CLKDIV</sub>	CLKDIV maximum frequency	270	262.5	250	125	MHz

## Output Serializer/Deserializer Switching Characteristics

Table 38: OSERDES2 Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Setup/Hold</b>						
T <sub>OSDCK_D</sub> / T <sub>OSCKD_D</sub>	D input Setup/Hold with respect to CLKDIV	-0.03/ 1.02	-0.03/ 1.17	-0.03/ 1.27	-0.02/ 0.23	ns
T <sub>OSDCK_T</sub> / T <sub>OSCKD_T</sub> <sup>(1)</sup>	T input Setup/Hold with respect to CLK	-0.05/ 1.03	-0.05/ 1.13	-0.05/ 1.23	-0.05/ 0.24	ns
T <sub>OSCCK_OCE</sub> / T <sub>OSCKC_OCE</sub>	OCE input Setup/Hold with respect to CLK	0.12/ -0.03	0.15/ -0.03	0.24/ -0.03	0.28/ -0.17	ns
T <sub>OSCCK_TCE</sub> / T <sub>OSCKC_TCE</sub>	TCE input Setup/Hold with respect to CLK	0.14/ -0.08	0.17/ -0.08	0.27/ -0.08	0.31/ -0.16	ns
<b>Sequential Delays</b>						
T <sub>OSCKO_OQ</sub>	Clock to out from CLK to OQ	0.94	1.11	1.51	1.89	ns
T <sub>OSCKO_TQ</sub>	Clock to out from CLK to TQ	0.94	1.11	1.51	1.91	ns
F <sub>CLKDIV</sub>	CLKDIV maximum frequency	270	262.5	250	125	MHz

**Notes:**

1. T<sub>OSDCK\_T2</sub> / T<sub>OSCKD\_T2</sub> (T input setup/hold with respect to CLKDIV) are reported as T<sub>OSDCK\_T</sub> / T<sub>OSCKD\_T</sub> in TRACE report.

## CLB Switching Characteristics (SLICEM Only)

Table 40: CLB Switching Characteristics (SLICEM Only)

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Combinatorial Delays</b>						
T <sub>ILO</sub>	An – Dn LUT inputs to A to D outputs	0.21	0.26	0.26	0.46	ns, Max
	An – Dn LUT inputs through F7AMUX/F7BMUX to AMUX/CMUX output	0.37	0.43	0.43	0.77	ns, Max
T <sub>OPAB</sub>	An – Dn LUT inputs through F7AMUX or F7BMUX and F8MUX to BMUX output	0.37	0.46	0.46	0.84	ns, Max
T <sub>ITO</sub>	An – Dn LUT inputs through latch to AQ – DQ outputs	0.82	0.95	0.95	1.64	ns, Max
T <sub>TITO_LOGIC</sub>	An – Dn LUT inputs to AQ – DQ outputs (latch as logic)	0.82	0.95	0.95	1.64	ns, Max
T <sub>OPCYA</sub>	An LUT inputs to COUT output	0.38	0.48	0.48	0.69	ns, Max
T <sub>OPCYB</sub>	Bn LUT inputs to COUT output	0.38	0.49	0.49	0.71	ns, Max
T <sub>OPCYC</sub>	Cn LUT inputs to COUT output	0.28	0.33	0.33	0.55	ns, Max
T <sub>OPCYD</sub>	Dn LUT inputs to COUT output	0.28	0.35	0.35	0.52	ns, Max
T <sub>AFCY</sub>	AX input to COUT output	0.21	0.26	0.26	0.36	ns, Max
T <sub>BFCY</sub>	BX input to COUT output	0.13	0.16	0.16	0.18	ns, Max
T <sub>CFCY</sub>	CX input to COUT output	0.10	0.12	0.12	0.09	ns, Max
T <sub>DXCY</sub>	DX input to COUT output	0.09	0.11	0.11	0.09	ns, Max
T <sub>BYP</sub>	CIN input to COUT output	0.08	0.10	0.10	0.06	ns, Max
T <sub>CINA</sub>	CIN input to AMUX output	0.21	0.22	0.22	0.47	ns, Max
T <sub>CINB</sub>	CIN input to BMUX output	0.30	0.31	0.31	0.57	ns, Max
T <sub>CINC</sub>	CIN input to CMUX output	0.29	0.31	0.31	0.58	ns, Max
T <sub>CIND</sub>	CIN input to DMUX output	0.31	0.32	0.32	0.68	ns, Max
<b>Sequential Delays</b>						
T <sub>CKO</sub>	Clock to AQ – DQ outputs	0.45	0.53	0.53	0.74	ns, Max
<b>Setup and Hold Times of CLB Flip-Flops Before/After Clock CLK</b>						
T <sub>DICK/T<sub>CKDI</sub></sub>	AX – DX input to CLK on A – D flip-flops	0.42/ 0.28	0.47/ 0.39	0.47/ 0.39	0.90/ 0.56	ns, Min
T <sub>CECK/T<sub>CKCE</sub></sub>	CE input to CLK on A – D flip-flops	0.31/ –0.07	0.37/ –0.07	0.37/ –0.07	0.59/ –0.27	ns, Min
T <sub>SRCK/T<sub>CKSR</sub></sub>	SR input to CLK on A – D flip-flops for XC devices	0.41/ 0.02	0.42/ 0.02	0.42/ 0.02	0.68/ –0.29	ns, Min
	SR input to CLK on A – D flip-flops for XA and XQ devices	0.41/ 0.02	N/A	0.44/ 0.02	0.68/ –0.29	ns, Min
T <sub>CINCK/T<sub>CKCIN</sub></sub>	CIN input to CLK on A – D flip-flops	0.31/ –0.17	0.31/ –0.13	0.31/ –0.13	0.81/ –0.42	ns, Min
<b>Set/Reset</b>						
T <sub>RPW</sub>	SR input minimum pulse width	0.41	0.48	0.48	1.37	ns, Min
T <sub>RQ</sub>	Delay from SR input to AQ – DQ flip-flops	0.60	0.70	0.70	0.88	ns, Max
T <sub>CEO</sub>	Delay from CE input to AQ – DQ flip-flops	0.60	0.65	0.65	0.90	ns, Max
F <sub>TOG</sub>	Toggle frequency (for export control)	862	806	667	500	MHz

## CLB Distributed RAM Switching Characteristics (SLICEM Only)

Table 41: CLB Distributed RAM Switching Characteristics (SLICEM Only)

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Sequential Delays</b>						
T <sub>SHCKO</sub>	Clock to A – D outputs	1.26	1.55	1.55	2.35	ns, Max
	Clock to A – D outputs (direct output path)	0.96	1.20	1.20	1.87	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>						
T <sub>DS</sub> /T <sub>DH</sub>	AX – DX or AI – DI inputs to CLK	0.59/ 0.17	0.73/ 0.22	0.73/ 0.22	1.17/ 0.33	ns, Min
T <sub>AS</sub> /T <sub>AH</sub>	Address An inputs to clock for XC devices	0.28/ 0.35	0.32/ 0.42	0.32/ 0.42	0.26/ 0.71	ns, Min
	Address An inputs to clock for XA and XQ devices	0.28/ 0.51	N/A	0.32/ 0.51	0.26/ 0.71	ns, Min
T <sub>WS</sub> /T <sub>WH</sub>	WE input to clock	0.31/ –0.08	0.37/ –0.08	0.37/ –0.08	0.59/ –0.27	ns, Min
T <sub>CECK</sub> /T <sub>CKCE</sub>	CE input to CLK	0.31/ –0.08	0.37/ –0.08	0.37/ –0.08	0.59/ –0.27	ns, Min

## CLB Shift Register Switching Characteristics (SLICEM Only)

Table 42: CLB Shift Register Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
<b>Sequential Delays</b>						
T <sub>REG</sub>	Clock to A – D outputs	1.35	1.78	1.78	2.74	ns, Max
	Clock to A – D outputs (direct output path)	1.24	1.65	1.65	2.48	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>						
T <sub>WS</sub> /T <sub>WH</sub>	WE input to CLK	0.20/ –0.07	0.24/ –0.07	0.24/ –0.07	0.29/ –0.27	ns, Min
T <sub>CECK</sub> /T <sub>CKCE</sub>	CE input to CLK for XC devices	0.30/ 0.30	0.30/ 0.38	0.30/ 0.38	0.82/ –0.41	ns, Min
	CE input to CLK for XA and XQ devices	0.32/ 0.30	N/A	0.40/ 0.38	0.82/ –0.41	ns, Min
T <sub>DS</sub> /T <sub>DH</sub>	AX – DX or AI – DI inputs to CLK	0.07/ 0.11	0.09/ 0.14	0.09/ 0.14	0.11/ 0.23	ns, Min

Table 44: DSP48A1 Switching Characteristics (Cont'd)

Symbol	Description	Pre-adder	Multiplier	Post-adder	Speed Grade				Units
					-3	-3N	-2	-1L	
$T_{DSPDCK\_OPMODE\_PREG}$ / $T_{DSPCKD\_OPMODE\_PREG}$	OPMODE input to P register CLK	Yes	Yes	Yes	6.21/ -0.84	7.27/ -0.84	7.27/ -0.84	10.43/ -0.84	ns
		No	Yes	Yes	1.69/ -0.87	1.98/ -0.87	1.98/ -0.87	3.62/ -0.87	ns
		No	No	Yes	2.09/ -0.22	2.30/ -0.22	2.30/ -0.22	3.79/ -0.22	ns
<b>Clock to Out from Output Register Clock to Output Pin</b>									
$T_{DSPCKO\_P\_PREG}$	CLK (PREG) to P output	N/A	N/A	N/A	1.20	1.34	1.34	1.90	ns
<b>Clock to Out from Pipeline Register Clock to Output Pins</b>									
$T_{DSPCKO\_P\_MREG}$	CLK (MREG) to P output	N/A	N/A	Yes	3.38	3.95	3.95	5.83	ns
<b>Clock to Out from Input Register Clock to Output Pins</b>									
$T_{DSPCKO\_P\_A1REG}$	CLK (A1REG) to P output	N/A	Yes	Yes	5.02	5.87	5.87	9.65	ns
$T_{DSPCKO\_P\_B1REG}$	CLK (B1REG) to P output	N/A	Yes	Yes	5.02	5.87	5.87	9.63	ns
$T_{DSPCKO\_P\_CREG}$	CLK (CREG) to P output	N/A	N/A	Yes	3.12	3.64	3.64	5.24	ns
$T_{DSPCKO\_P\_DREG}$	CLK (DREG) to P output	Yes	Yes	Yes	6.77	7.92	7.92	12.53	ns
<b>Combinatorial Delays from Input Pins to Output Pins</b>									
$T_{DSPDO\_A\_P}$	A input to P output	N/A	No	Yes	2.85	3.33	3.33	4.73	ns
		N/A	Yes	No <sup>(2)</sup>	3.35	3.93	3.93	6.74	ns
		N/A	Yes	Yes	4.56	5.22	5.22	8.94	ns
$T_{DSPDO\_B\_P}$	B input to P output	Yes	No	No <sup>(2)</sup>	3.22	3.76	3.76	5.55	ns
		Yes	Yes	No <sup>(2)</sup>	6.01	6.54	6.54	9.76	ns
		Yes	Yes	Yes	6.27	7.34	7.34	11.96	ns
$T_{DSPDO\_C\_P}$	C input to P output	N/A	N/A	Yes	2.69	3.15	3.15	4.68	ns
$T_{DSPDO\_D\_P}$	D input to P output	Yes	Yes	Yes	6.31	7.38	7.38	11.81	ns
$T_{DSPDO\_OPMODE\_P}$	OPMODE input to P output	Yes	Yes	Yes	6.43	7.52	7.52	11.84	ns
		No	Yes	Yes	4.84	5.66	5.66	9.25	ns
		No	No	Yes	3.11	3.49	3.49	5.03	ns
<b>Maximum Frequency</b>									
$F_{MAX}$	All registers used	Yes	Yes	Yes	390	333	333	213	MHz

**Notes:**

1. A Yes signifies that the component is in the path. A No signifies that the component is being bypassed. N/A signifies not applicable because no path exists.
2. Implemented in the post-adder by adding to zero.

## DCM Switching Characteristics

Table 53: Operating Frequency Ranges and Conditions for the Delay-Locked Loop (DLL)<sup>(1)</sup>

Symbol	Description	Speed Grade								Units	
		-3		-3N		-2		-1L			
		Min	Max	Min	Max	Min	Max	Min	Max		
<b>Input Frequency Ranges</b>											
CLKIN_FREQ_DLL	Frequency of the CLKIN clock input when the CLKDV output is not used.	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	250 <sup>(3)</sup>	5 <sup>(2)</sup>	175 <sup>(3)</sup>	MHz	
	Frequency of the CLKIN clock input when using the CLKDV output.	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	280 <sup>(3)</sup>	5 <sup>(2)</sup>	250 <sup>(3)</sup>	5 <sup>(2)</sup>	133 <sup>(3)</sup>	MHz	
<b>Input Pulse Requirements</b>											
CLKIN_PULSE	CLKIN pulse width as a percentage of the CLKIN period for CLKIN_FREQ_DLL < 150 MHz	40	60	40	60	40	60	40	60	%	
	CLKIN pulse width as a percentage of the CLKIN period for CLKIN_FREQ_DLL > 150 MHz	45	55	45	55	45	55	45	55	%	
<b>Input Clock Jitter Tolerance and Delay Path Variation<sup>(4)</sup></b>											
CLKIN_CYC_JITT_DLL_LF	Cycle-to-cycle jitter at the CLKIN input for CLKIN_FREQ_DLL < 150 MHz	–	±300	–	±300	–	±300	–	±300	ps	
CLKIN_CYC_JITT_DLL_HF	Cycle-to-cycle jitter at the CLKIN input for CLKIN_FREQ_DLL > 150 MHz.	–	±150	–	±150	–	±150	–	±150	ps	
CLKIN_PER_JITT_DLL	Period jitter at the CLKIN input.	–	±1	–	±1	–	±1	–	±1	ns	
CLKFB_DELAY_VAR_EXT	Allowable variation of the off-chip feedback delay from the DCM output to the CLKFB input.	–	±1	–	±1	–	±1	–	±1	ns	

### Notes:

1. DLL specifications apply when using any of the DLL outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, or CLKDV.
2. When operating independently of the DLL, the DFS supports lower CLKIN\_FREQ\_DLL frequencies. See Table 55.
3. The CLKIN\_DIVIDE\_BY\_2 attribute increases the effective input frequency range. When set to TRUE, the input clock frequency is divided by two as it enters the DCM. Input clock frequencies for the clock buffer being used can be increased up to the F<sub>MAX</sub> (see Table 48 and Table 49 for BUFG and BUFIO2 limits). When used with CLK\_FEEDBACK=2X, the input clock frequency matches the frequency for CLK2X, and is limited to CLKOUT\_FREQ\_2X.
4. CLKIN\_FREQ\_DLL input jitter beyond these limits can cause the DCM to lose LOCK, indicated by the LOCKED output deasserting. The user must then reset the DCM.
5. When using both DCMs in a CMT, both DCMs must be LOCKED.

Table 59: Switching Characteristics for the Phase-Shift Clock in Variable Phase Mode<sup>(1)</sup>

Symbol	Description	Amount of Phase Shift	Units
<b>Phase Shifting Range</b>			
MAX_STEPS <sup>(2)</sup>	When CLKIN < 60 MHz, the maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. When using CLKIN_DIVIDE_BY_2 = TRUE, double the clock-effective clock period.	$\pm(\text{INTEGER}(10 \times (\text{CLKIN} - 3 \text{ ns})))$	steps
	When CLKIN $\geq$ 60 MHz, the maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. When using CLKIN_DIVIDE_BY_2 = TRUE, double the clock-effective clock period.	$\pm(\text{INTEGER}(15 \times (\text{CLKIN} - 3 \text{ ns})))$	steps
FINE_SHIFT_RANGE_MIN	Minimum guaranteed delay for variable phase shifting.	$\pm(\text{MAX_STEPS} \times \text{DCM_DELAY_STEP_MIN})$	ps
FINE_SHIFT_RANGE_MAX	Maximum guaranteed delay for variable phase shifting	$\pm(\text{MAX_STEPS} \times \text{DCM_DELAY_STEP_MAX})$	ps

**Notes:**

- The values in this table are based on the operating conditions described in Table 53 and Table 58.
- The maximum variable phase shift range, MAX\_STEPS, is only valid when the DCM has no initial fixed-phase shifting, that is, the PHASE\_SHIFT attribute is set to 0.
- The DCM\_DELAY\_STEP values are provided at the end of Table 54.

Table 60: Miscellaneous DCM Timing Parameters<sup>(1)</sup>

Symbol	Description	Min	Max	Units
DCM_RST_PW_MIN	Minimum duration of a RST pulse width	3	–	CLKIN cycles

**Notes:**

- This limit only applies to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFXDV, CLKFX180) are unaffected.

Table 61: Frequency Synthesis

Attribute	Min	Max
CLKFX_MULTIPLY (DCM_SP)	2	32
CLKFX_DIVIDE (DCM_SP)	1	32
CLKDV_DIVIDE (DCM_SP)	1.5	16
CLKFX_MULTIPLY (DCM_CLKGEN)	2	256
CLKFX_DIVIDE (DCM_CLKGEN)	1	256
CLKFXDV_DIVIDE (DCM_CLKGEN)	2	32

Table 62: DCM Switching Characteristics

Symbol	Description	Speed Grade				Units
		-3	-3N	-2	-1L	
T <sub>DMCCK_PSEN</sub> /T <sub>DMCKC_PSEN</sub>	PSEN Setup/Hold	1.50/ 0.00	1.50/ 0.00	1.50/ 0.00	1.50/ 0.00	ns
T <sub>DMCCK_PSINCDEC</sub> /T <sub>DMCKC_PSINCDEC</sub>	PSINCDEC Setup/Hold	1.50/ 0.00	1.50/ 0.00	1.50/ 0.00	1.50/ 0.00	ns
T <sub>DMCKO_PSDONE</sub>	Clock to out of PSDONE	1.50	1.50	1.50	1.50	ns

Table 65: Global Clock Input to Output Delay With DCM in Source-Synchronous Mode

Symbol	Description	Device	Speed Grade				Units
			-3	-3N	-2	-1L	
LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in Source-Synchronous Mode.							
T <sub>CLOCKOFDCM_0</sub>	Global Clock and OUTFF <i>with</i> DCM	XC6SLX4	5.03	N/A	7.21	8.05	ns
		XC6SLX9	5.03	6.13	7.21	8.05	ns
		XC6SLX16	5.08	5.51	6.44	7.96	ns
		XC6SLX25	4.81	5.13	5.69	7.94	ns
		XC6SLX25T	4.81	5.13	5.69	N/A	ns
		XC6SLX45	5.26	5.69	6.63	7.92	ns
		XC6SLX45T	5.26	5.69	6.63	N/A	ns
		XC6SLX75	4.77	5.18	5.88	7.95	ns
		XC6SLX75T	4.77	5.18	5.88	N/A	ns
		XC6SLX100	4.72	5.11	5.76	8.59	ns
		XC6SLX100T	4.76	5.11	5.76	N/A	ns
		XC6SLX150	4.90	5.30	5.93	7.93	ns
		XC6SLX150T	4.90	5.30	5.93	N/A	ns
		XA6SLX4	5.35	N/A	7.21	N/A	ns
		XA6SLX9	5.35	N/A	7.21	N/A	ns
		XA6SLX16	5.42	N/A	6.44	N/A	ns
		XA6SLX25	5.13	N/A	5.69	N/A	ns
		XA6SLX25T	5.13	N/A	5.79	N/A	ns
		XA6SLX45	5.58	N/A	6.63	N/A	ns
		XA6SLX45T	5.58	N/A	6.63	N/A	ns
		XA6SLX75	5.09	N/A	5.87	N/A	ns
		XA6SLX75T	5.09	N/A	5.87	N/A	ns
		XA6SLX100	N/A	N/A	6.44	N/A	ns
		XQ6SLX75	N/A	N/A	5.87	7.95	ns
		XQ6SLX75T	5.09	N/A	5.87	N/A	ns
		XQ6SLX150	N/A	N/A	6.06	7.93	ns
		XQ6SLX150T	5.50	N/A	6.06	N/A	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

## Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
06/24/09	1.0	Initial Xilinx release.
08/26/09	1.1	Added $V_{FS}$ to <a href="#">Table 1</a> and <a href="#">Table 2</a> . Added $R_{FUSE}$ to <a href="#">Table 2</a> . Added XC6SLX75 and XC6SLX75T to $V_{BATT}$ and $I_{BATT}$ in <a href="#">Table 1</a> , <a href="#">Table 2</a> , and <a href="#">Table 4</a> . Corrected the quiescent supply current for the XC6SLX4 in <a href="#">Table 5</a> . Updated <a href="#">Table 11</a> . Removed $DV_{PPIN}$ from <a href="#">Figure 2</a> . Removed $F_{PCIECORE}$ from <a href="#">Table 24</a> and added values to $F_{PCIEUSER}$ . Added more networking applications to <a href="#">Table 25</a> . Updated values for $T_{SUSPENDLOW\_AWAKE}$ , $T_{SUSPEND\_ENABLE}$ , and $T_{SCP\_AWAKE}$ in <a href="#">Table 46</a> . Numerous changes to <a href="#">Table 47, page 54</a> including the addition of new values to various specifications, revising the $T_{SMCKCSO}$ description, and changing the units of $T_{POR}$ . Also, removed <i>Dynamic Reconfiguration Port (DRP) for DCM and PLL Before and After DCLK section</i> from <a href="#">Table 47</a> and updated all the notes. In <a href="#">Table 52</a> , added to $F_{INMAX}$ , revised $F_{OUTMAX}$ , and removed PLL Maximum Output Frequency for BUFI02. Revised values for DCM_DELAY_STEP in <a href="#">Table 54</a> . Updated CLKIN_FREQ_FX values in <a href="#">Table 55</a> .
01/04/10	1.2	Added -4 speed grade to entire document. Updated speed specification of -4, -3, -2 speed grades to version 1.03. Added -1L speed grade numbers per speed specification 1.00. Updated $T_{SOL}$ in <a href="#">Table 1</a> . Added -1L rows for LVCMOS12, LVCMOS15, and LVCMOS18 in <a href="#">Table 9</a> . Revised much of the detail in <a href="#">GTP Transceiver Specifications</a> in <a href="#">Table 12</a> through <a href="#">Table 23</a> . Added -2 data to <a href="#">Table 25</a> . Updated $F_{MAX}$ in <a href="#">Table 44</a> . Updated descriptions for $T_{DNACLKL}$ and $T_{DNACLKH}$ in <a href="#">Table 45</a> and revised values for all parameters. Removed $T_{INITADDR}$ from <a href="#">Table 47</a> and added new data. Updated values in <a href="#">Table 48</a> through <a href="#">Table 62</a> . Added <a href="#">Table 51</a> (BUFPLL) and <a href="#">Table 57</a> (DCM_CLKGEN). Removed $T_{LOCKMAX}$ note from <a href="#">Table 52</a> . Updated note 3 in <a href="#">Table 53</a> . In <a href="#">Table 79</a> : removed XC6SLX75CSG324 and XC6SLX75TCG324; added XC6SLX75FG(G)484 and XC6SLX75FG(G)484.
02/22/10	1.3	Production release of XC6SLX16 -2 speed grade devices. The changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> includes updating this data sheet to the data in ISE v11.5 software with speed specification v1.06. Updated maximum of $V_{IN}$ and $V_{TS}$ and note 2 in <a href="#">Table 1</a> . In <a href="#">Table 2</a> , changed $V_{IN}$ , added $I_{IN}$ and note 5, revised notes 1, 6, and 7, and added note 8 to $R_{FUSE}$ . In <a href="#">Table 4</a> , removed previous note 1 and added data to $I_{RPU}$ , $I_{RPD}$ , and $I_{BATT}$ ; changed $C_{IN}$ , added $R_{DT}$ and $R_{IN\_TERM}$ , and added note 2 and 3. Updated $V_{CCO2}$ in <a href="#">Table 6</a> . Added <a href="#">Table 7</a> and <a href="#">Table 8</a> . Removed PCI66_3 from <a href="#">Table 9</a> . Updated PCI33_3 and I2C in <a href="#">Table 9</a> . Updated the description of <a href="#">Table 11</a> . Completely updated <a href="#">Table 25</a> . Updated <a href="#">Table 28</a> including adding values for PCI33_3. Updated $V_{REF}$ value for HSTL_III_18 in <a href="#">Table 31</a> . Updates missing $V_{REF}$ values in <a href="#">Table 32</a> . Added <a href="#">Simultaneously Switching Outputs, page 36</a> . Removed $T_{GSRQ}$ and $T_{RPW}$ from <a href="#">Table 35</a> and <a href="#">Table 36</a> . Also removed $T_{DOQ}$ from <a href="#">Table 36</a> . Removed $T_{ISPO\_DO}$ and note 1 from <a href="#">Table 37</a> . Removed $T_{OSCCK\_S}$ and combinatorial section from <a href="#">Table 38</a> . In <a href="#">Table 39</a> , removed $T_{IODDO\_T}$ and added new tap parameters and note 2. In <a href="#">Table 40</a> , <a href="#">Table 41</a> , and <a href="#">Table 42</a> , made typographical edits and removed notes. Removed clock CLK section in <a href="#">Table 41</a> . Removed clock CLK section and $T_{REG\_MUX}$ and $T_{REG\_M31}$ in <a href="#">Table 42</a> . Added block RAM $F_{MAX}$ values to <a href="#">Table 43</a> . Updated values and added note 2 to <a href="#">Table 45</a> . Added values to <a href="#">Table 46</a> and removed note 1. Numerous changes to <a href="#">Table 47</a> . Completely updated <a href="#">Table 57</a> . Revised data in <a href="#">Table 62</a> . Removed note 3 from <a href="#">Table 71</a> . Added values to <a href="#">Table 79</a> . Added data to <a href="#">Table 80</a> and <a href="#">Table 81</a> .
03/10/10	1.4	Production release of XC6SLX45 -2 speed grade devices, which includes changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> updating this data sheet to the data in ISE v11.5 software with speed specification v1.07. Fixed $R_{IN\_TERM}$ description in <a href="#">Table 4</a> . Added PCI66_3 to <a href="#">Table 7</a> and replaced note 1. Corrected note 1 and the V <sub>Max</sub> for TMDS_33 in <a href="#">Table 8</a> . In <a href="#">Table 10</a> , added note 1 to LVPECL_33 and TMDS_33. Also updated specifications for TMDS_33. Updated the <a href="#">GTP Transceiver Specifications</a> section including adding values to <a href="#">Table 16</a> , <a href="#">Table 17</a> , and <a href="#">Table 20</a> through <a href="#">Table 23</a> . Added PCI66_3 back into <a href="#">Table 9</a> , <a href="#">Table 28</a> , <a href="#">Table 31</a> , <a href="#">Table 32</a> , and <a href="#">Table 34</a> . Updated note 3 on <a href="#">Table 32</a> . In <a href="#">Table 34</a> , corrected some typographical errors and fixed SSO limits for bank1/3 in FG(G)484 package. Corrected $T_{OSCCK\_OC_E}$ in <a href="#">Table 38</a> . In <a href="#">Table 57</a> , updated CLKFX_FREEZE_VAR and CLKFX_FREEZE_TEMP_SLOPE and added typical values to $T_{CENTER\_LOW\_SPREAD}$ and $T_{CENTER\_HIGH\_SPREAD}$ . Updated and added values to <a href="#">Table 63</a> through <a href="#">Table 78</a> , and <a href="#">Table 81</a> . In <a href="#">Table 79</a> , revised the XC6SLX16-CSG324 and the XC6SLX45-CSG484 and FG(G)484 values.

Date	Version	Description of Revisions
06/14/10	1.5	<p>In <a href="#">Table 2</a>, added note 5 and added temperature range to <math>V_{FS}</math> and <math>R_{FUSE}</math>. Removed speed grade delineation, revised <math>I_{RPD}</math> description, and updated note 2 in <a href="#">Table 4</a>. Added note 2 to <a href="#">Table 7</a>. Added DIFF_MOBILE_DDR to <a href="#">Table 8</a> and <a href="#">Table 10</a>. Added note 4 to <a href="#">Table 15</a>. Changed minimum <math>DV_{PPIN}</math> in <a href="#">Table 16</a>. Updated <math>F_{GTPDRPCLK}</math> in <a href="#">Table 19</a>. Increased maximum <math>T_{LLSKEW}</math> in <a href="#">Table 22</a>. Updated descriptions and added data to <a href="#">Table 23</a>. Removed note 1 and added new data to the Networking Applications section in <a href="#">Table 25</a>. Updated <a href="#">Table 26</a> and <a href="#">Table 27</a> to the data in ISE v12.1 software with speed specification v1.08. In <a href="#">Table 28</a>, added DIFF_MOBILE_DDR and updated -4 speed grade data. Updated the maximum I/O pairs per bank in <a href="#">Table 33</a>. Updated note 2 on <a href="#">Table 39</a>. Revised the <math>F_{MAX}</math> in <a href="#">Table 44</a>. In <a href="#">Table 47</a>, updated description for <math>T_{SMCKCSO}</math>, revised values for <math>T_{POR}</math> and added Min value, added <math>T_{BPICCK}</math> and <math>T_{SPIICCK}</math>. Also in <a href="#">Table 47</a>, added device dependencies to <math>F_{SMCCK}</math> and <math>F_{RBCCCK}</math>. Updated and added data to <a href="#">Table 63</a> through <a href="#">Table 78</a>, and <a href="#">Table 81</a>. In <a href="#">Table 79</a>, added data on the XC6SLX45-FG(G)676 and revised the XC6SLX45T and XC6SLX150T values.</p> <p>The following changes to this specification are addressed in the product change notice <a href="#">XCN10024</a>, <i>MCB Performance and JTAG Revision Code for Spartan-6 LX16 and LX45 FPGAs</i>.</p> <p>In <a href="#">Table 2</a>, revised the <math>V_{CCINT}</math> to add the memory controller block extended performance specifications. In <a href="#">Table 25</a>, changed the standard specifications and added extended performance specifications for the memory controller block and note 2. Added note 4 and updated values in <a href="#">Table 34</a>.</p>
06/24/10	1.6	<p>Production release of XC6SLX45T (-2 and -3 speed grades), XC6SLX16 and XC6SLX45 (-3 speed grade) devices which includes changes to <a href="#">Table 26</a> and <a href="#">Table 27</a> (ISE v12.1 software with speed specification v1.08).</p> <p>Added the -3N speed grade, which designates Spartan-6 devices that do not support MCB functionality. This includes changes to <a href="#">Table 2</a> (note 2), <a href="#">Table 25</a> (note 4), and <a href="#">Switching Characteristics (Table 26)</a>.</p> <p>Updated <a href="#">Simultaneously Switching Outputs</a> discussion. Added -3 speed grade values for <math>T_{TAP}</math> and <math>F_{MINCAL}</math> values in <a href="#">Table 39</a>. In <a href="#">Table 40</a>, updated <math>T_{RPW}</math> (-2 and -3 speed grade) values and <math>F_{TOG}</math> (-3 speed grade) values. In <a href="#">Table 48</a>, updated <math>T_{GIO}</math> (-2 and -3 speed grade) values. Updated -3 values in spread spectrum section of <a href="#">Table 57</a>.</p>
07/16/10	1.7	<p>Production release of specific devices listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.2 software with speed specification v1.11. Added note 4 advising designers of the patch which contains v1.11. Also updated the -1L speed specification to v1.04. Updated numerous -4 and -1L values. Added -4 <math>T_{TAP}</math> values and <math>F_{MINCAL}</math> to <a href="#">Table 39</a>. Revised <math>T_{CINCK}/T_{CKCIN}</math> in <a href="#">Table 40</a>. In <a href="#">Table 41</a>, revised <math>T_{SHCKO}</math>. In <a href="#">Table 42</a>, revised <math>T_{REG}</math>. Added new -1L values to <a href="#">Table 47</a>. Added and updated values in <a href="#">Table 79</a>.</p>
07/26/10	1.8	<p>Production release of XC6SLX25, XC6SLX25T, XC6SLX100 and XC6SLX100T in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.2 software with speed specification v1.11. Added note 7 to <a href="#">Table 2</a> and moved <math>V_{FS}</math> and <math>R_{FUSE}</math> to a new <a href="#">Table 3</a>. Added <math>I_{HS}</math> and note 4 to <a href="#">Table 4</a>. Added note 1 to <a href="#">Table 28</a>. Added and updated SSO limits per <math>V_{CCO}/GND</math> pairs in <a href="#">Table 34</a>. Added note 3 to <a href="#">Table 47</a>. In <a href="#">Table 54</a>, removed -1L specifications for CLKOUT_PER_JITT_DV1/2 and revised CLKIN_CLKFB_PHASE and CLKOUT_PHASE_DLL values. Updated note 3 in both <a href="#">Table 56</a> and <a href="#">Table 57</a>.</p>
08/23/10	1.9	<p>Updated values for <math>F_{GTPRANGE1}</math>, <math>F_{GTPRANGE2}</math>, and <math>F_{GPLLMIN}</math> in <a href="#">Table 18</a>. Revised -3 and -4 values in <a href="#">Table 21</a>. Removed the -1L speed grade readback support restriction and note 3 in <a href="#">Table 47</a>.</p>
11/05/10	1.10	<p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.3 software with speed specification v1.12 for the -2 speed grade available in the 12.3 Speed Files Patch. Added note 3 advising designers of the patch which contains v1.12.</p> <p>In <a href="#">Table 2</a>, added note 4. In <a href="#">Table 4</a>, added note 2. In <a href="#">Table 10</a>, added notes 2 and 3. In <a href="#">Table 44</a>, added note 2. In <a href="#">Table 47</a>, updated symbol for <math>T_{SMWCCK}/T_{SMCCW}</math>, changed -1L values for <math>T_{USERCCLKH}</math> and <math>T_{USERCCLKL}</math>, and added and revised the modes for <math>F_{MCCK}</math> and <math>F_{SMCCK}</math>. In <a href="#">Table 53</a>, redefined and expanded description for CLKIN_FREQ_DLL and rewrote note 3. Updated title of <a href="#">Table 58</a>. Also in <a href="#">Table 78</a>, revised <math>T_{DCD\_CLK}</math> for XC6SLX150 and XC6SLX150T. Changed description of <math>T_{PSFD}/T_{PHFD}</math> in <a href="#">Table 71</a>.</p> <p>For the -1L speed grade, updated data sheet to ISE 12.3 software with speed specification v1.05 which revised the values in the following tables: <a href="#">Table 25</a>, <a href="#">Table 28</a>, <a href="#">Table 35</a>, <a href="#">Table 36</a>, <a href="#">Table 37</a>, <a href="#">Table 40</a> through <a href="#">Table 43</a>, <a href="#">Table 48</a> through <a href="#">Table 56</a>, <a href="#">Table 62</a> through <a href="#">Table 78</a>, <a href="#">Table 80</a>, and <a href="#">Table 81</a>.</p> <p>Updated <a href="#">Notice of Disclaimer</a>.</p>

Date	Version	Description of Revisions
01/10/11	1.11	<p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v12.4 software with speed specification v1.15 for the -4, -3, -3N, and -2 speed grades. Added note 3 to <a href="#">Table 27</a>. Also updated the -1L speed grade requirements to ISE v12.4 software with speed specification v1.06. Revised -3N definition throughout the document.</p> <p>Added note 4 to <a href="#">Table 2</a> and updated note 5. Added information on <math>V_{CCINT}</math> to note 1 in <a href="#">Table 5</a>. Updated Networking Applications -3 values in <a href="#">Table 25</a> to match improvements made in ISE v12.4. In <a href="#">Table 28</a>, added note 1 and revised the <math>T_{IOTP}</math> values for LVDS_33, LVDS_25, MINI_LVDS_33, MINI_LVDS_25, RSDS_33, RSDS_25, TMDS_33, PPDS_33, and PPDS_25. Added note 3 to <a href="#">Table 55</a>.</p>
02/11/11	1.12	<p>As described in <a href="#">XCN11008: Product Discontinuation Notice For Spartan-6 LXT -4 Devices</a>, the -4 speed specifications have been discontinued. As outlined in page 2 of the XCN, designers currently using -4 speed specifications should rerun timing analysis using the new -3 speed specifications before moving to a replacement device.</p> <p>Updated the networking applications section of <a href="#">Table 25</a>. Updated -2 speed specifications throughout document and added note 3 to <a href="#">Table 27</a> advising designers to use the -2 speed specification update (v1.17) with the ISE 12.4 software patch. Added <math>F_{CLKDIV}</math> to <a href="#">Table 37</a> and <a href="#">Table 38</a>. Updated note 2 in <a href="#">Table 39</a>. Updated units for <math>T_{SMCKCSO}</math> and <math>T_{BPICCO}</math> in <a href="#">Table 47</a>. Updated -1L in <a href="#">Table 71</a>. Removed Note 2: <i>Package delay information is available for these device/package combinations. This information can be used to deskew the package from Table 79.</i></p>
03/31/11	2.0	<p>Production release of XC6SLX45 in the -1L speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06.</p> <p>In <a href="#">Table 39</a>, removed values in the -1L column and added note 3 as IODELAY2 only supports Tap0 for lower-power devices. Updated copyright <a href="#">page 1</a> and <a href="#">Notice of Disclaimer</a>.</p>
05/20/11	2.1	<p>Production release of XC6SLX100 and XC6SLX150 in the specific speed grades listed in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.1 software with -1L speed specification v1.06. Updated <a href="#">Table 27</a> and <a href="#">Note 7</a> with changes per <a href="#">XCN11012: Speed File Change for -3N Devices</a>. Revised <a href="#">Switching Characteristics</a> section for speed specifications: v1.18 for -3, -3N, and -2; including improvements in <a href="#">Table 73</a> through <a href="#">Table 77</a> and <a href="#">Table 81</a>.</p> <p>Removed <i>Memory Controller Block</i> from the performance heading in <a href="#">Table 2</a> and revised <a href="#">Note 2</a>. In <a href="#">Table 4</a>, added <a href="#">Note 1</a> to <math>C_{IN}</math> and updated the description of <math>R_{IN\_TERM}</math>. Updated <a href="#">Note 1</a> in <a href="#">Table 5</a>. Updated <a href="#">Note 1</a> of <a href="#">Table 7</a>. In <a href="#">Table 25</a>, added and removed -1L specifications, increased the standard performance DDR3 specifications, removed the extended performance DDR3 row and updated <a href="#">Note 3</a> and <a href="#">Note 4</a>. Clarified the introductory information for <a href="#">Table 28</a> and <a href="#">Table 30</a>.</p> <p>In <a href="#">Table 32</a>: Revised <math>V_{MEAS}</math> value for LVCMOS12; revised <math>V_{REF}</math> for LVDS_25, LVDS_33, BLVDS_25, MINI_LVDS_25, MINI_LVDS_33, RSDS_25, and RSDS_33; revised <math>R_{REF}</math> for BLVDS_25 and TMDS_33; and added <a href="#">Note 4</a> and <a href="#">Note 5</a>. Updated <a href="#">Note 2</a> and <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p> <p>In <a href="#">Table 47</a>, revised the values and description of <math>T_{POR}</math> including adding <a href="#">Note 3</a>. Also in <a href="#">Table 47</a>, augmented the description and added specifications for <math>F_{RBCK}</math> and removed XC6SLX4 from <math>F_{MCCK}</math> (maximum frequency, parallel mode (Master SelectMAP/BPI)). Added BUFGMUX to <a href="#">Table 48</a> title. Added <a href="#">Table 50</a>.</p> <p>In <a href="#">Table 52</a>, revised specifications for <math>T_{EXTFDVAR}</math> and <math>F_{INJITTER}</math>. In <a href="#">Table 54</a> removed the 5 MHz &lt; <math>CLKIN\_FREQ\_DLL</math> parameter in the <math>LOCK\_DLL</math> description. In both <a href="#">Table 56</a> and <a href="#">Table 57</a>, removed the 5 MHz &lt; <math>F_{CLKIN}</math> parameter in the <math>LOCK\_FX</math> description. In <a href="#">Table 58</a>, updated description for <math>PSCLK\_FREQ</math> and <math>PSCLK\_PULSE</math>.</p> <p>Revised title and symbol of <a href="#">Table 70</a>, added new speed specifications for -1L, and added <a href="#">Note 2</a>. Added <a href="#">Table 71</a>.</p>
07/11/11	2.2	<p>Added the Automotive XA Spartan-6 and Defense-grade Spartan-6Q devices to all appropriate tables while sometimes removing the XC6S nomenclature. Added expanded temperature range (Q) to all appropriate tables. Updated <math>T_{SOL}</math> packages in <a href="#">Table 1</a>. Added <math>R_{OUT\_TERM}</math> to <a href="#">Table 4</a>. Updated <a href="#">Note 2</a> on <a href="#">Table 13</a>.</p> <p>Production release of the XC6SLX4, XC6SLX9, XC6SLX16, XC6SLX25, XC6SLX75, XQ6SLX75, and XQ6SLX150 in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -1L speed specification v1.07.</p> <p>Production release of the XA6SLX16, XA6SLX25T, XA6SLX45, XA6SLX45T, XQ6SLX75, XQ6SLX75T, XQ6SLX150, and XQ6SLX150T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.</p> <p>Added <a href="#">Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices(1)</a>. Updated CS(G)484 from CSG484 throughout data sheet. Clarified <a href="#">Note 3</a> in <a href="#">Table 39</a>.</p>
08/08/11	2.3	Production release of the XA6SLX25, XA6SLX75, and XA6SLX75T in <a href="#">Table 26</a> and <a href="#">Table 27</a> using ISE v13.2 software with -2 and -3 speed specification v1.19.